

MIC4467/4468/4469

Quad 1.2A-Peak Low-Side MOSFET Driver

Bipolar/CMOS/DMOS

General Description

Logic Diagrams

The MIC4467/8/9 family of 4-output CMOS buffer/drivers is an expansion from the earlier single- and dual-output drivers, to which they are functionally closely related. Because package pin count permitted it, each driver has been equipped with a 2-input logic gate for added flexibility. Placing four high-power drivers in a single package also improves system reliability and reduces total system cost. In some applications, one of these drivers can replace not only two packages of single-input drivers, but some of the associated logic as well.

Although primarily intended for driving power MOSFETs, and similar highly capacitive loads, these drivers are equally well suited to driving any other load (capacitive, resistive, or inductive), which requires a high-efficiency, low-impedance driver capable of high peak currents, rail-to-rail voltage swings, and fast switching times. For example, heavily loaded clock lines, coaxial cables, and piezoelectric transducers can all be driven easily with MIC446X series drivers. The only limitation

Features

- Built using reliable, low power CMOS processes
- Latchproof. Withstands 500mA Inductive Kickback
- 3 Input Logic Choices
- Symmetrical Rise and Fall Times......25ns
- Short, Equal Delay Times75ns
- High Peak Output Current......1.2A
- Wide Operating Range4.5 to 18V
- Low Equivalent Input Capacitance (typ)6pF
- Inputs = Logic 1 for Any Input From 2.4V to V_s
- ESD Protected

Applications

- General-Purpose CMOS Logic Buffer
- Driving All 4 MOSFETs in an H-Bridge
- Direct Small-Motor Driver
- Relay or Peripheral Drivers
- Dual Differential Output Power Drivers
- CCD Driver
- Pin-Switching Network Driver

MIC4467 **MIC4468 MIC4469** Vs ٧s ٧s Q 14 14 . 14 1 ¹³₀ 1Y ¹³o 1Y 1A O 1A O-1A O-<u>13</u>о 1Ү 2 2 2 1B o-1B o-1B o-3 3 3 ¹²o 2Y 2A o-2A o-2A o-2B 0 4 -0 2Y o 2Y 2B 0 4 2B o-3A o 5 3A o 5 3A o<u>5</u> ¹¹ o 3Y 11 11 o 3Y 3B o 6 -o 3Y 3B o 6 3B o_6 4A o<u>8</u> 4A o<u>8</u> 4A o<u>8</u> ¹⁰o 4Y <u>10</u>о 4Ү <u>10</u>o 4Y 4B 0 9 4B o 9 4B o 9 7 7 7 GND GND GND

on loading is that total power dissipation in the IC must be kept within the power dissipation limits of the package.

The MIC446X series drivers are built using a BCD process. They will not latch under any conditions within their power and voltage ratings. They are not subject to damage when up to 5V of noise spiking (either polarity) occurs on the ground line. They can accept up to half an amp of inductive kickback current (either polarity) into their outputs without damage or logic upset.

Ordering Information

Part Number		Temperature	
Standard	Pb-Free	Range	Package
MIC44xxCN*	MIC44xxZN*	0°C to +70°C	14-pin Plastic DIP
MIC44xxCWM*	MIC44xxZWM*	0°C to +70°C	16-pin Wide SOIC
MIC44xxBN*	MIC44xxYN*	–40°C to +85°C	14-pin Plastic DIP
MIC44xxBWM*	MIC44xxYWM*	–40°C to +85°C	16-pin Wide SOIC

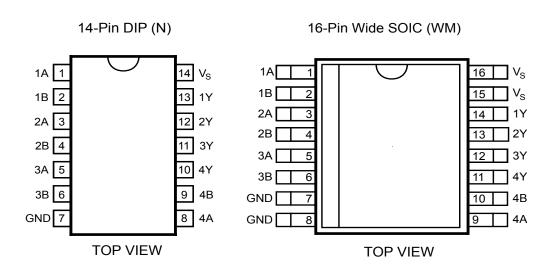
* xx identifies input logic:

67 — NAND 68 — AND 69 — AND with 1 inverting input **Pb-Free industrial grade PDIP available in MIC4468 & MIC4469 only.

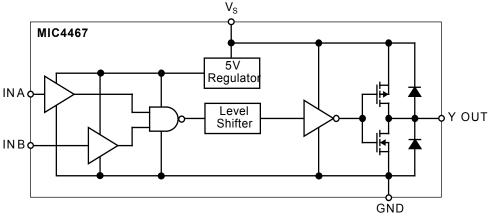
Truth Table

	Inp	Output	
Part No.	Α	В	Y
MIC4467 (Each Driver)	L X H	X L H	ΤΙΙ
MIC4468 (Each Driver)	H L X	НХL	HLL
MIC4469 (Each Driver)	L X H	X H L	L L H

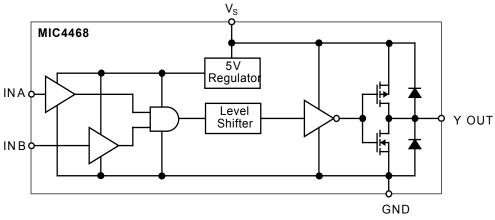
Pin Configurations



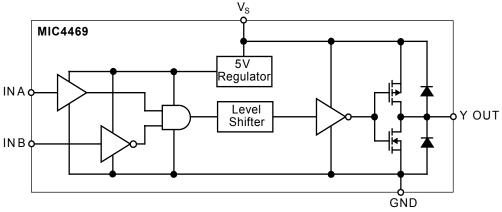
Block Diagrams



Functional Diagram for One Driver (Four Drivers per Package–Ground Unused Inputs)



Functional Diagram for One Driver (Four Drivers per Package-Ground Unused Inputs)



Functional Diagram for One Driver (Four Drivers per Package-Ground Unused Inputs)

Absolute Maximum Ratings (Notes 1 and 2)

Supply Voltage	22V	I
Input Voltage	$(GND - 5V)$ to $(V_s + 0.3V)$	
Maximum Chip Temperature	0	
Operating	150°C	
Storage	–65° to +150°C	I
Maximum Load Temperature		
(10 sec, for soldering)	300°C	
Operating Ambient Temperature	e	
C Version	0° to +70°C	
B Version	–40° to +85°C	

Power Dissipation N Package (14-Pin Plastic DIP) WM Package (16-Pin Wide SOIC)	1.5W 1W
Package Thermal Resistance N Package (14-Pin Plastic DIP) θ _{JA} WM Package (16-Pin Wide SOIC) θ _{JA}	80°C/W 120°C/W

Electrical Characteristics: Measured at $T_A = 25^{\circ}C$ with $4.5V \le V_S \le 18V$ unless otherwise specified. (Note 3)

Symbol	Parameter	Conditions	Min	Тур	Мах	Units
INPUT					1	1
V _{IH}	Logic 1 Input Voltage		2.4	1.3		V
V _{IL}	Logic 0 Input Voltage			1.2	0.8	V
I _{IN}	Input Current	$0 \le V_{IN} \le V_{S}$	-1		1	μA
OUTPUT			I			
V _{OH}	High Output Voltage	I _{LOAD} = 10mA	V _s -0.15			V
V _{OL}	Low Output Voltage	I _{LOAD} = 10mA			0.15	V
R _o	Output Resistance	I _{OUT} = 10mA, V _s = 18V		5	15	Ω
I _{РК}	Peak Output Current			1.2		A
I	Latch-Up Protection Withstand Reverse Current		>500			mA
SWITCHIN	IG TIME					
t _R	Rise Time	Test Figure 1		14	25	ns
t _F	Fall Time	Test Figure 1		13	25	ns
t _{D1}	Delay Time	Test Figure 1		30	75	ns
t _{D2}	Delay Time	Test Figure 1		45	75	ns
POWER S	UPPLY					
I _s	Power Supply Current			0.2	4	mA

Note 3. Specification for packaged product only.

Supply

Electrical Characteristics:

Measured over operating temperature range with 4.5V \leq V $_{\rm S}$ \leq 18V unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
INPUT	-		L L	1	1	1
V _{IH}	Logic 1 Input Voltage		2.4	1.4		V
V	Logic 0 Input Voltage			1.0	0.8	V
I _{IN}	Input Current	$0 \le V_{iN} \le V_{S}$	-1		1	μA
OUTPUT	-		•	•	•	•

V _{OH}	High Output Voltage	I _{LOAD} = 10 mA	V _s -0.3			V
V _{OL}	Low Output Voltage	I _{LOAD} = 10 mA			0.3	V
R _o	Output Resistance	I _{OUT} = 10 mA, V _s = 18V		7	30	Ω
I _{PK}	Peak Output Current			1.2		A
I	Latch-Up Protection Withstand Reverse Current		500			mA

SWITCHING TIME

t _R	Rise Time	Test Figure 1	17	50	ns
t _F	Fall Time	Test Figure 1	16	50	ns
t _{D1}	Delay Time	Test Figure 1	35	100	ns
t _{D2}	Delay Time	Test Figure 1	55	100	ns

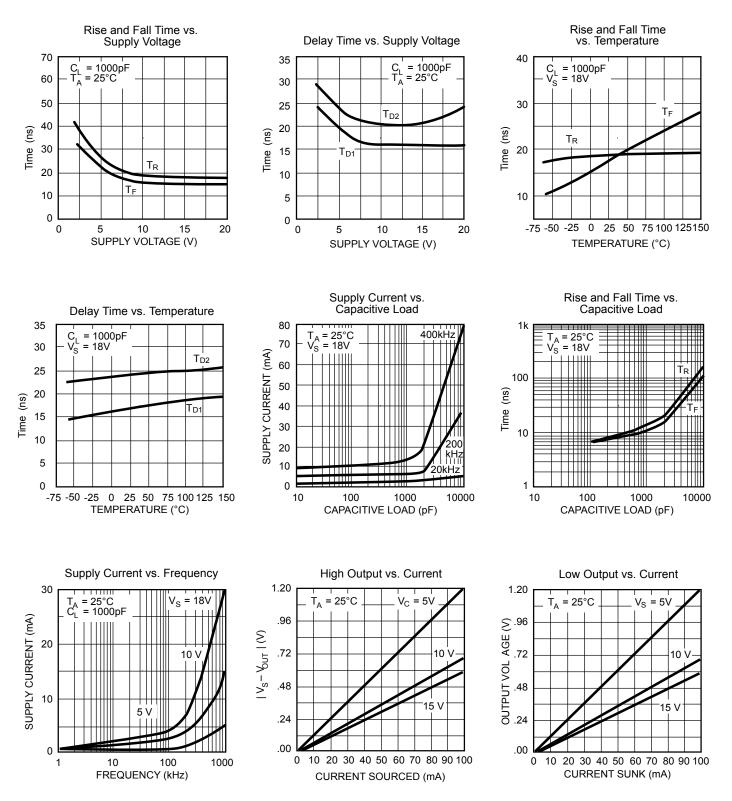
POWER SUPPLY

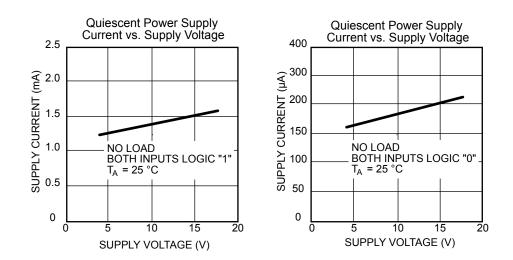
۱ _s	Power Supply Current Supply		0.4	8	mA

NOTE 1: Functional operation above the absolute maximum stress ratings is not implied.

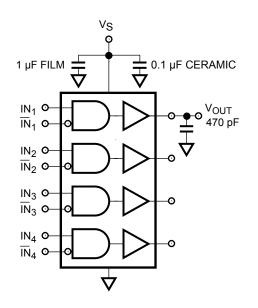
NOTE 2: Static sensitive device. Store only in conductive containers. Handling personnel and equipment should be grounded to prevent static damage.

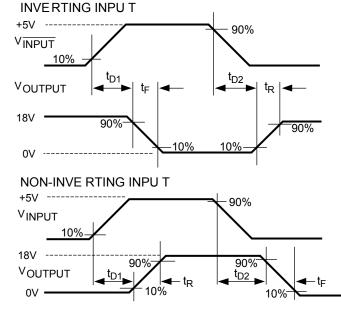
Typical Characteristics



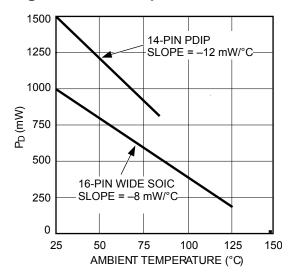


Test Figure 1

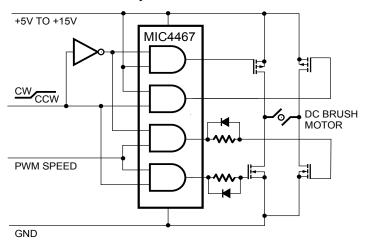




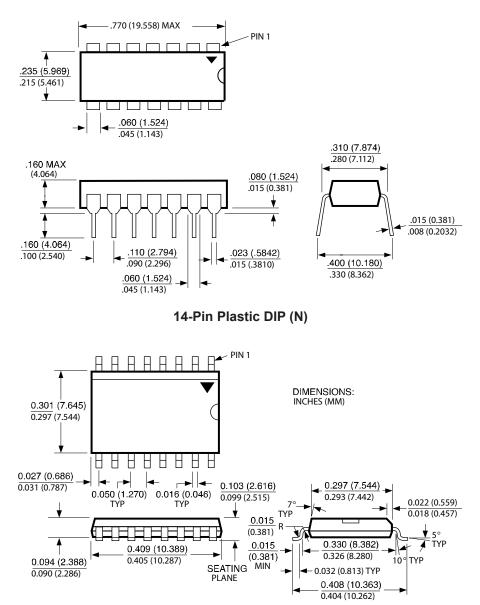
Package Power Dissipation



Quad Driver Drives H Bridge to Control Motor Speed and Direction



Package Information



16-Pin Wide SOP (WM)

MICREL INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA TEL + 1 (408) 944-0800 FAX + 1 (408) 474-1000 WEB http://www.micrel.com

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